

描述 / Descriptions

PDFN3×3-8L 塑封封装互补增强模式场效应管。

Complementary Enhancement MOSFET in a PDFN3×3-8L Plastic Package.

特征 / Features

N-channel

$V_{DS}(V)=30V$ $I_D=37A$

$R_{DS(ON)}@10V<8m\Omega$ (Typ.7.5mR)

$R_{DS(ON)}@4.5V<15m\Omega$ (Typ.11mR)

无卤产品。HF Product.

P-channel

$V_{DS}(V)=-30V$ $I_D=-26A$

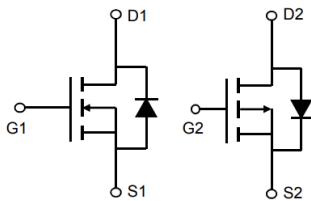
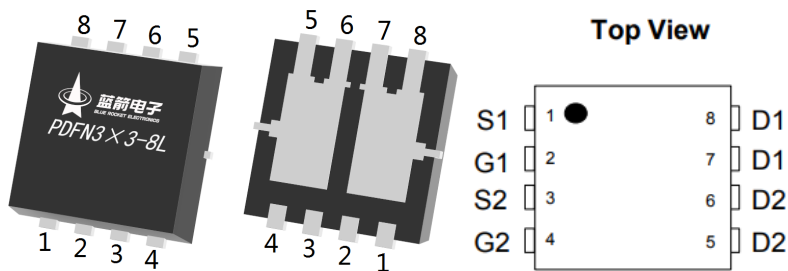
$R_{DS(ON)}@-10V<13m\Omega$ (Typ.12mR)

$R_{DS(ON)}@-4.5V<20m\Omega$ (Typ.17mR)

用途 / Applications

电池保护开关，移动设备电池充放电，负载开关。

Battery protection switch, Mobile device battery charging and discharging, Load switch.

内部等效电路 / Equivalent Circuit**引脚排列 / Pinning****印章代码 / Marking**

见印章说明。

See Marking Instructions.

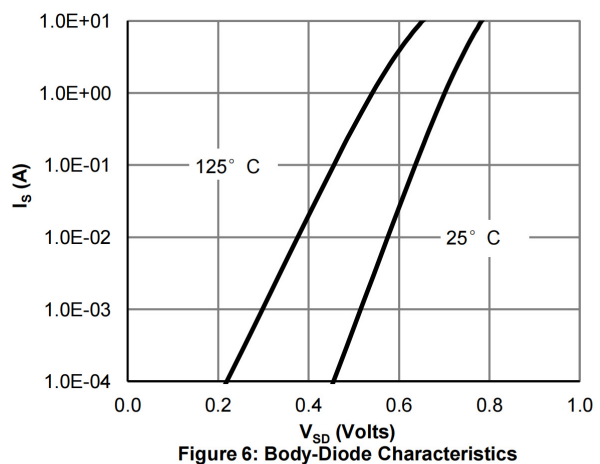
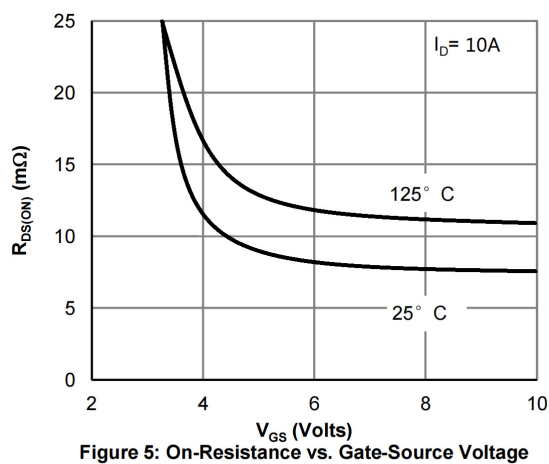
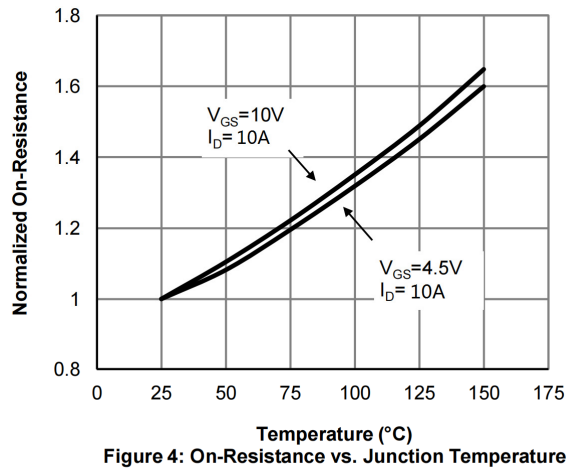
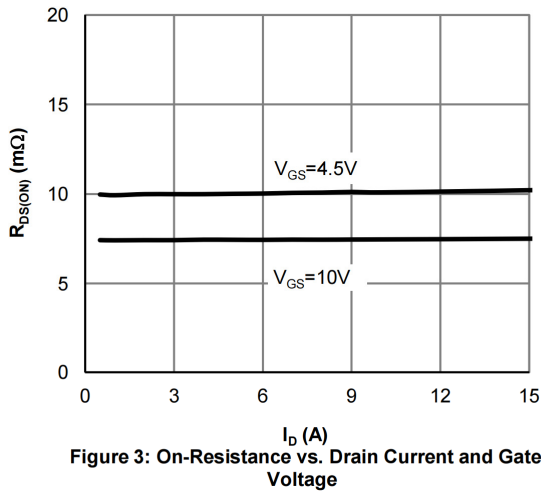
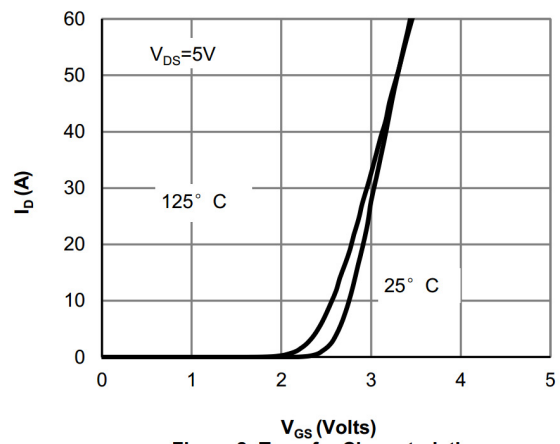
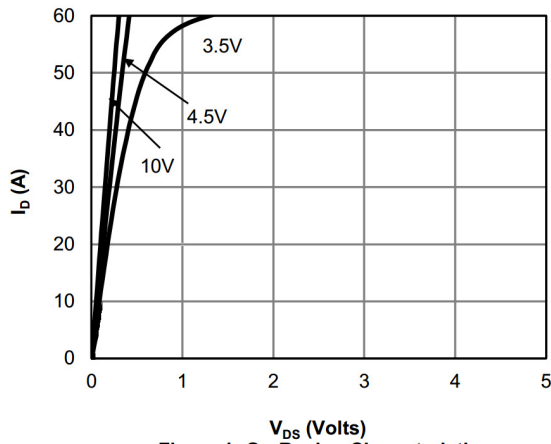
极限参数 / Absolute Maximum Ratings(Ta=25°C)

参数 Parameter	符号 Symbol	数值 Rating		单位 Unit
		N-channe	P-channell	
Drain-Source Voltage	V_{DSS}	30	-30	V
Gate-Source Voltage	V_{GSS}	± 20		V
Continuous Drain Current	$I_D(T_c=25^\circ\text{C})$	37	-26	A
Pulsed Drain Current	I_{DM}	82	-58	A
Power Dissipation	$P_D(T_c=25^\circ\text{C})$	18	15	W
Junction and Storage Temperature Range	T_J, T_{STG}	-55 to +150		$^\circ\text{C}$
Maximum Junction-to-Case	$R_{\theta JA}$	6.9	8.3	$^\circ\text{C/W}$

N-沟道电性能参数/N-CHANNEL Electrical Characteristics(Ta=25℃)

参数 Parameter	符号 Symbol	测试条件 Test Conditions	最小值 Min	典型值 Typ	最大值 Max	单位 Unit
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{GS}=0V$ $I_D=250\mu A$	30	35.5		V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=30V$ $V_{GS}=0V$			1.0	μA
Gate-Body leakage current	I_{GSS}	$V_{GS}=\pm 20V$ $V_{DS}=0V$			± 100	nA
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}$ $I_D=250\mu A$	1.0	1.8	2.5	V
Static Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS}=10V$ $I_D=10A$		7.5	8	m Ω
		$V_{GS}=4.5V$ $I_D=10A$		11	15	m Ω
Diode Forward Voltage	V_{SD}	$V_{GS}=0V$ $I_S=1.0A$			1.4	V
Input Capacitance	C_{iss}	$V_{DS}=25V$ $V_{GS}=0V$ $f=1.0MHz$		1170		pF
Output Capacitance	C_{oss}			110		pF
Reverse Transfer Capacitance	C_{rss}			100		pF
Gate resistance	R_g	$V_{DS}=0V$ $V_{GS}=0V$ $f=1.0MHz$		3.7		Ω
Total Gate Charge	$Q_{g(10V)}$	$V_{GS}=10V$ $V_{DS}=15V$ $I_D=10A$		40		nC
Total Gate Charge	$Q_{g(4.5V)}$			22		nC
Gate-Source Charge	Q_{gs}			11		nC
Gate-Drain Charge	Q_{gd}			5		nC
Turn-On Delay Time	$t_{d(on)}$	$V_{DS}=15V$ $V_{GS}=10V$ $R_L=0.75\Omega$ $R_{GEN}=3\Omega$		11		ns
Turn-On Rise Time	t_r			14		ns
Turn-Off Delay Time	$t_{d(off)}$			38		ns
Turn-Off Fall Time	t_f			10		ns

N-沟道电参数曲线图 / N-CHANNEL Electrical Characteristic Curve



N-沟道电参数曲线图 / N-CHANNEL Electrical Characteristic Curve

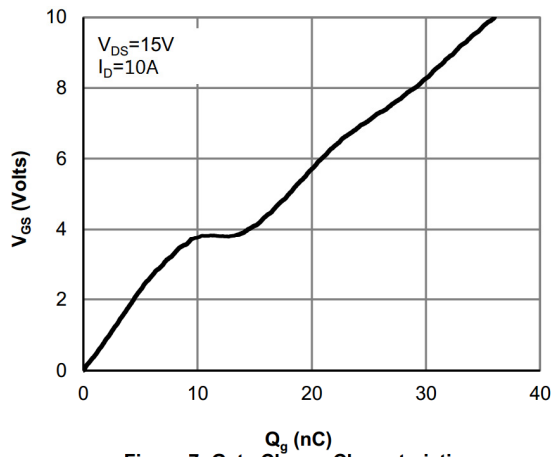


Figure 7: Gate-Charge Characteristics

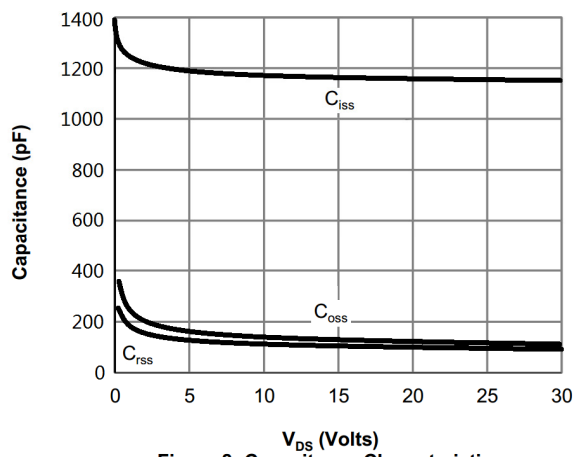


Figure 8: Capacitance Characteristics

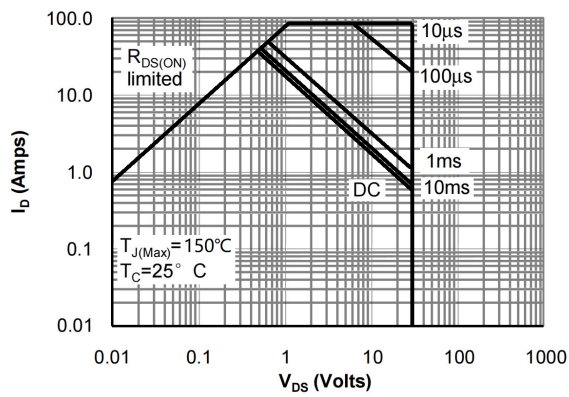


Figure 9: Maximum Forward Biased Safe Operating Area

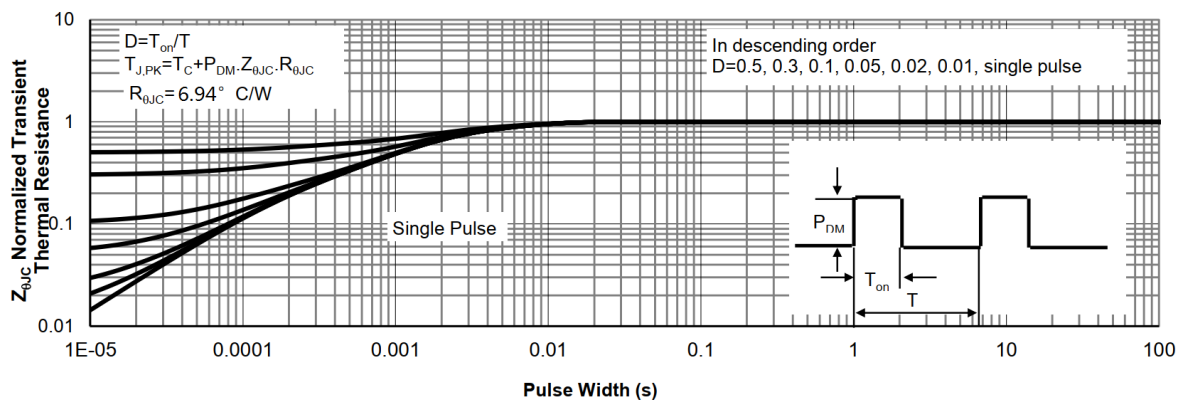


Figure 10: Normalized Maximum Transient Thermal Impedance

P-沟道电性能参数/P-CHANNEL Electrical Characteristics(Ta=25℃)

参数 Parameter	符号 Symbol	测试条件 Test Conditions	最小值 Min	典型值 Typ	最大值 Max	单位 Unit
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =-250μA	-30			V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-30 V _{GS} =0V			-1.0	μA
Gate-Body leakage current	I _{GSS}	V _{GS} =±20V V _{DS} =0V			±100	nA
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} I _D =-250μA	-1.0	-1.5	-2.5	V
Static Drain-Source On-Resistance	R _{DS(on)}	V _{GS} =-10V I _D =-10A		12	13	mΩ
		V _{GS} =-4.5V I _D =-10A		17	20	mΩ
Diode Forward Voltage	V _{SD}	V _{GS} =0V I _S =-1.0A			-1.4	V
Input Capacitance	C _{iss}	V _{DS} =-25V V _{GS} =0V f=1.0MHz		2100		pF
Output Capacitance	C _{oss}			1900		pF
Reverse Transfer Capacitance	C _{rss}			640		pF
Gate resistance	R _g	V _{DS} =0V V _{GS} =0V f=1.0MHz		4		Ω
Total Gate Charge	Q _{g(10V)}	V _{GS} =-10V V _{DS} =-15V I _D =-10A		35		nC
Total Gate Charge	Q _{g(4.5V)}			17		nC
Gate-Source Charge	Q _{gs}			5.7		nC
Gate-Drain Charge	Q _{gd}			8.8		nC
Turn-On Delay Time	t _{d(on)}	V _{DS} =-15 V V _{GS} =-10V R _L =1Ω R _{GEN} =3Ω		11		ns
Turn-On Rise Time	t _r			7.5		ns
Turn-Off Delay Time	t _{d(off)}			43.5		ns
Turn-Off Fall Time	t _f			17.5		ns

P-沟道电参数曲线图 / P-CHANNEL Electrical Characteristic Curve

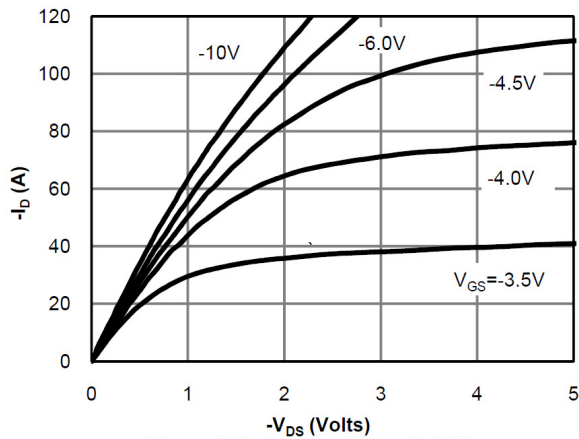


Figure 1: On-Region Characteristics

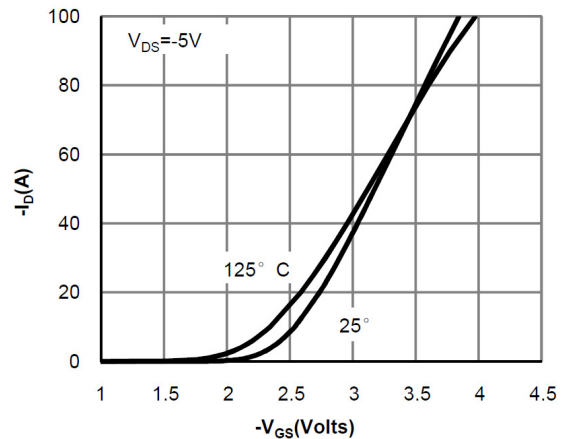


Figure 2: Transfer Characteristics

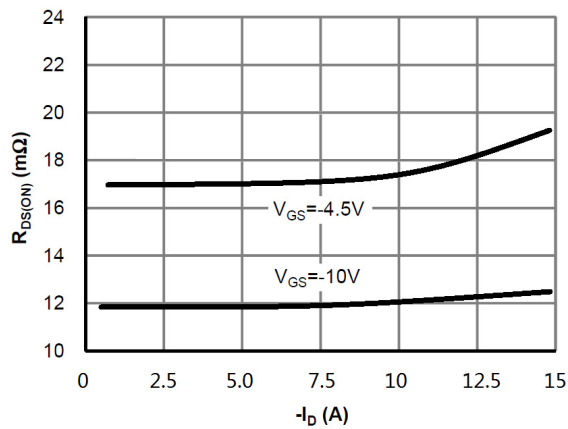


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

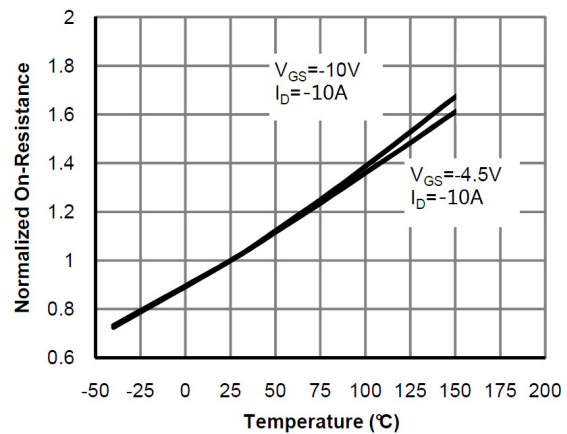


Figure 4: On-Resistance vs. Junction Temperature

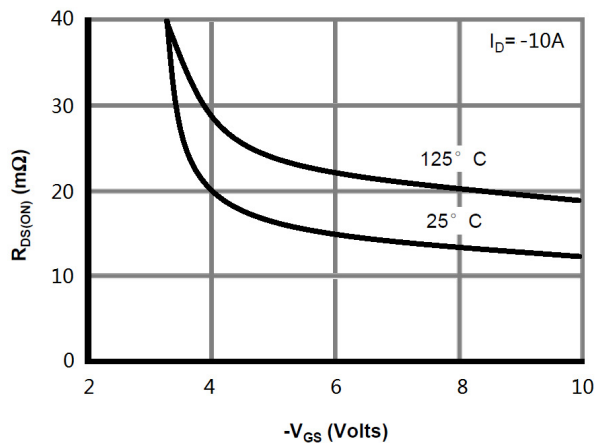


Figure 5: On-Resistance vs. Gate-Source Voltage

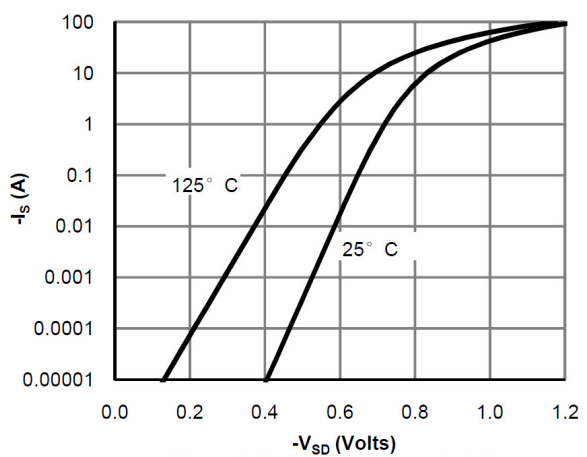
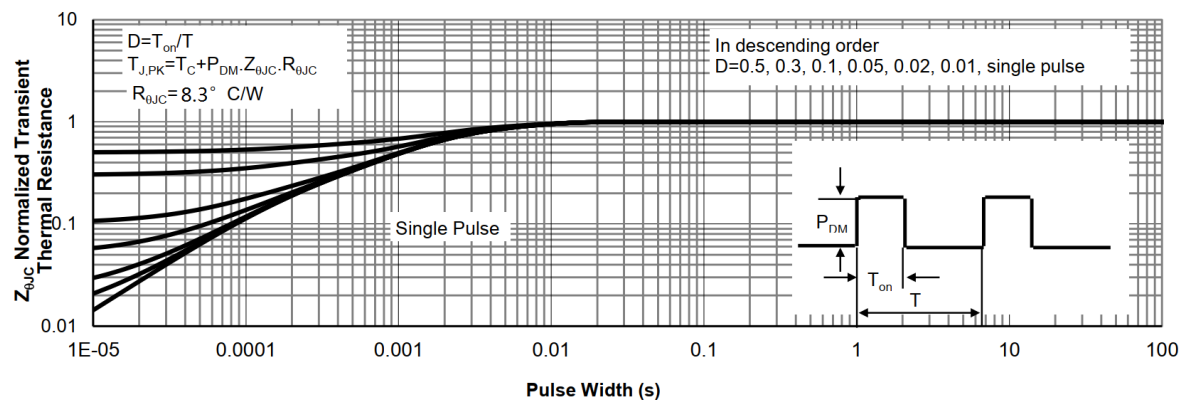
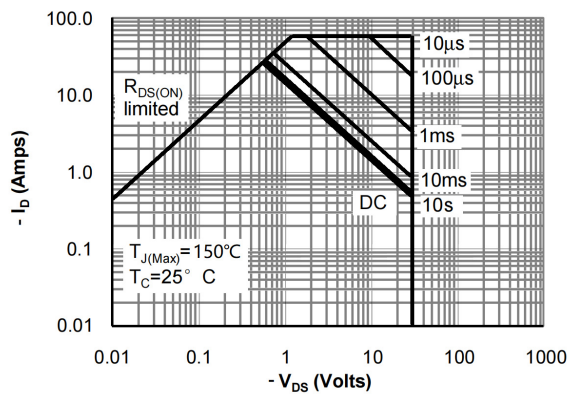
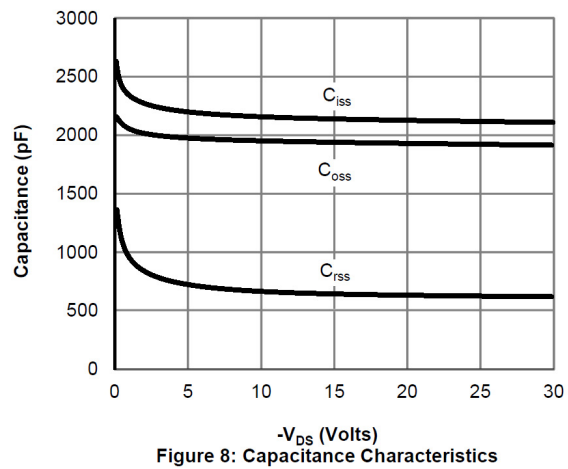
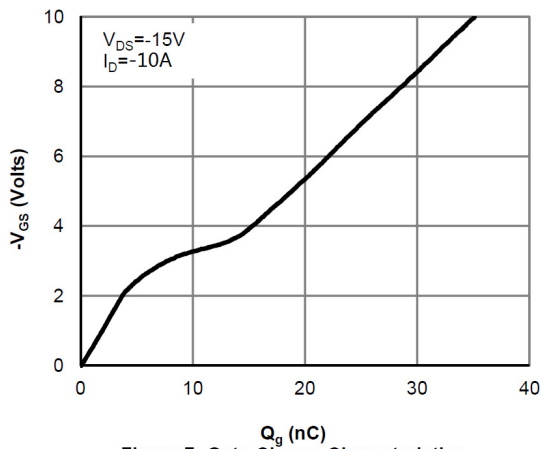


Figure 6: Body-Diode Characteristics

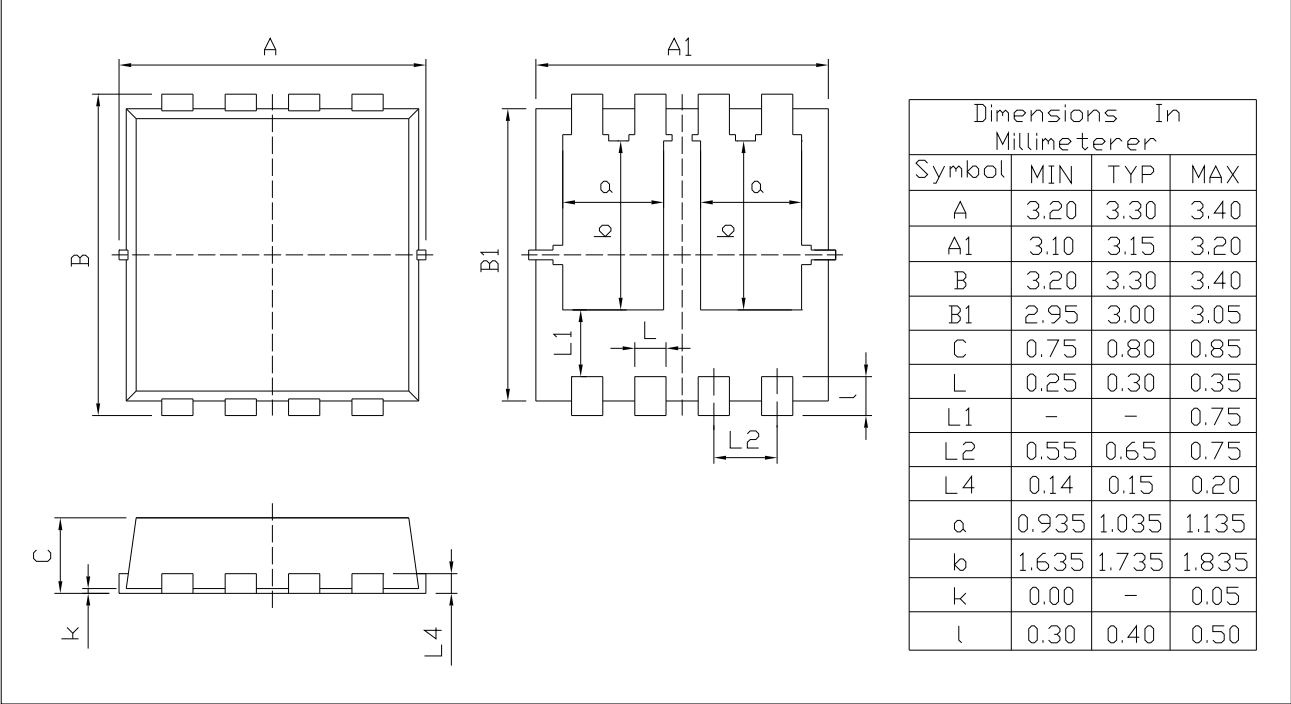
P-沟道电参数曲线图 / P-CHANNEL Electrical Characteristic Curve



外形尺寸图 / Package Dimensions

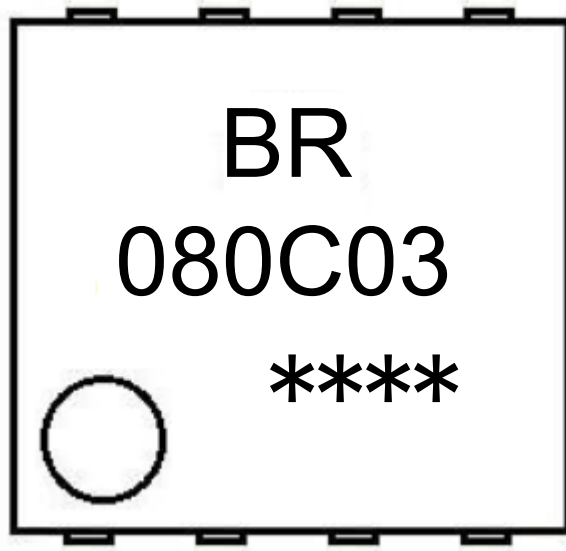
PDFN3X3-8L

Unit:mm



Rev.00 202011

印章说明 / Marking Instructions



说明：

BR： 为公司代码

080C03： 为型号代码

*****： 为生产批号代码，随生产批号变化

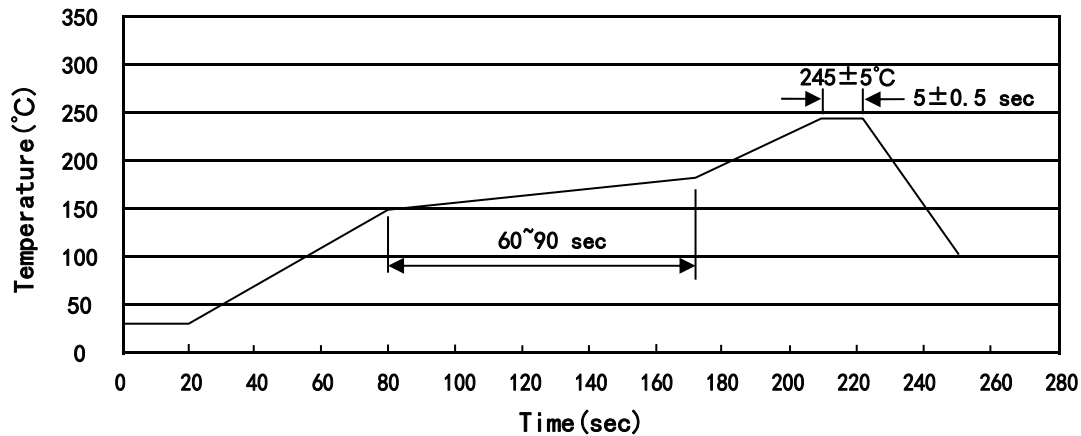
Note:

BR: Company Code

080C03: Product Type Code

*****: Lot No. Code, code change with Lot No

回流焊温度曲线图(无铅) / Temperature Profile for IR Reflow Soldering(Pb-Free)



说明：

- 1、预热温度 150~180°C，时间 60~90sec;
- 2、峰值温度 245±5°C，时间持续为 5±0.5sec;
- 3、焊接制程冷却速度为 2~10°C/sec.

Note:

- 1.Preheating:150~180°C, Time:60~90sec.
- 2.Peak Temp.:245±5°C, Duration:5±0.5sec.
3. Cooling Speed: 2~10°C/sec.

耐焊接热试验条件 / Resistance to Soldering Heat Test Conditions

温度：260±5°C

时间：10±1 sec.

Temp.:260±5°C

Time:10±1 sec

包装规格 / Packaging SPEC.

卷盘包装 / REEL

Package Type 封装形式	Units 包装数量					Dimension 包装尺寸 (unit: mm ³)		
	Units/Reel 只/卷盘	Reels/Inner Box 卷盘/盒	Units/Inner Box 只/盒	Inner Boxes/Outer Box 盒/箱	Units/Outer Box 只/箱	Reel	Inner Box 盒	Outer Box 箱
PDFN3×3-8L	5,000	2	10,000	6	60,000	13" ×12	360×360×50	380×335×366

使用说明 / Notices